

## TSA50N25M

### 250V N-Channel MOSFET

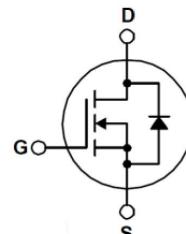
#### General Description

This Power MOSFET is produced using Truesemi's advanced planar stripe DMOS technology. This advanced technology has been especially tailored to minimize on-state resistance, provide superior switching performance, and withstand high energy pulse in the avalanche and commutation mode.



#### Features

- 50A, 250V, Max.RDS(on)=0.078Ω @ VGS =10V
  - ♦ Fast switching speed
  - ♦ Low gate charge
  - ♦ RoHS compliant device
- Applications
- ♦ Synchronous Rectification
  - ♦ Power Management in Inverter System



#### Absolute Maximum Ratings

T<sub>c</sub>=25°C unless otherwise specified

Symbol	Parameter		Value	Units
V <sub>DSS</sub>	Drain-Source Voltage		250	V
V <sub>GS</sub>	Gate-Source Voltage		± 30	V
I <sub>D</sub>	Drain Current	T <sub>c</sub> = 25°C	50	A
		T <sub>c</sub> = 100°C	31.6	A
I <sub>DM</sub>	Pulsed Drain Current		200	A
E <sub>AS</sub>	Single Pulsed Avalanche Energy (Note 1)		1250	mJ
I <sub>AS</sub>	Single avalanche current		20	A
P <sub>D</sub>	Power Dissipation (T <sub>c</sub> = 25°C)		245	W
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature Range		-55 to +150	°C

\* Limited only maximum junction temperature

#### Thermal Resistance Characteristics

Symbol	Parameter	Typ.	Max.	Units
R <sub>θJC</sub>	Thermal Resistance,Junction-to-Case	--	0.51	°C/W
R <sub>θJA</sub>	Thermal Resistance,Junction-to-Ambient	--	50.0	°C/W

**Electrical Characteristics**  $T_c=25^\circ\text{C}$  unless otherwise specified

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
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**On Characteristics**

$V_{GS(\text{th})}$	Gate Threshold Voltage	$V_{DS} = V_{GS}$ , $I_D = 250 \mu\text{A}$	2	--	4	V
$R_{DS(\text{ON})}$	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}$ , $I_D = 25 \text{ A}$	--	0.065	0.078	$\Omega$
$R_g$	Internal gate resistance	$V_{GS}=0\text{V}$ , $V_{DS}=0\text{V}$ , $f=1\text{MHz}$	--	0.8	--	$\Omega$

**Off Characteristics**

$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS} = 0 \text{ V}$ , $I_D = 250 \mu\text{A}$	250	--	--	V
$I_{DSS}$	Drain-source cut-off current	$V_{DS} = 250 \text{ V}$ , $V_{GS} = 0 \text{ V}$	--	--	1	$\mu\text{A}$
$I_{GSS}$	Gate leakage current	$V_{DS}=0\text{V}$ , $V_{GS}=\pm 30\text{V}$	--	--	$\pm 100$	nA

**Dynamic Characteristics**

$C_{iss}$	Input Capacitance	$V_{DS} = 25 \text{ V}$ , $V_{GS} = 0 \text{ V}$ , $f = 1.0 \text{ MHz}$ (Note 3,4)	--	5521	--	pF
$C_{oss}$	Output Capacitance		--	395	--	pF
$C_{rss}$	Reverse Transfer Capacitance		--	42	--	pF

**Switching Characteristics**

$t_{d(on)}$	Turn-On Time	$V_{DD} = 125 \text{ V}$ , $I_D = 50 \text{ A}$ , $R_G = 25 \Omega$ , $V_{GS} = 10 \text{ V}$ (Note 3,4)	--	55	--	ns
$t_r$	Turn-On Rise Time		--	50	--	ns
$t_{d(off)}$	Turn-Off Delay Time		--	212	--	ns
$t_f$	Turn-Off Fall Time		--	31	--	ns
$Q_g$	Total Gate Charge	$V_{DS} = 200 \text{ V}$ , $I_D = 50 \text{ A}$ , $V_{GS} = 10 \text{ V}$ (Note 3,4)	--	76	--	nC
$Q_{gs}$	Gate-Source Charge		--	20	--	nC
$Q_{gd}$	Gate-Drain Charge		--	25	--	nC

**Source-Drain Diode Maximum Ratings and Characteristics**

$I_s$	Continuous Source-Drain Diode Forward Current	--	--	50	A	
$I_{SM}$	Pulsed Source-Drain Diode Forward Current	--	--	200		
$V_{SD}$	Source-Drain Diode Forward Voltage	$I_{SD} = 50 \text{ A}$ , $V_{GS} = 0 \text{ V}$	--	--	1.2	V
$t_{rr}$	Reverse Recovery Time	$I_{SD} = 50 \text{ A}$ , $V_{GS} = 0 \text{ V}$ $dI_F/dt = 100 \text{ A}/\mu\text{s}$ (Note 3,4)	--	271	--	ns
$Q_{rr}$	Reverse Recovery Charge		--	2.4	--	uC

**NOTES:**1.  $L=5\text{mH}$ ,  $I_{AS}=20 \text{ VDD}=50 \text{ V}$ , Starting  $T_J=25^\circ\text{C}$ 2. Pulse test: Pulse width  $\leq 300\text{us}$ , Duty cycle  $\leq 2\%$ 

3. Essentially independent of operating temperature typical characteristics

4. Guaranteed by design, not subject to production testing.

## Typical Electrical Characteristics Curves

Fig. 1  $I_D$  -  $V_{DS}$

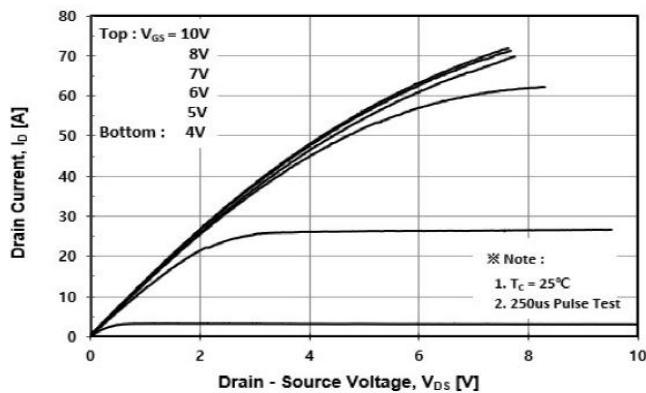


Fig. 2  $I_D$  -  $V_{GS}$

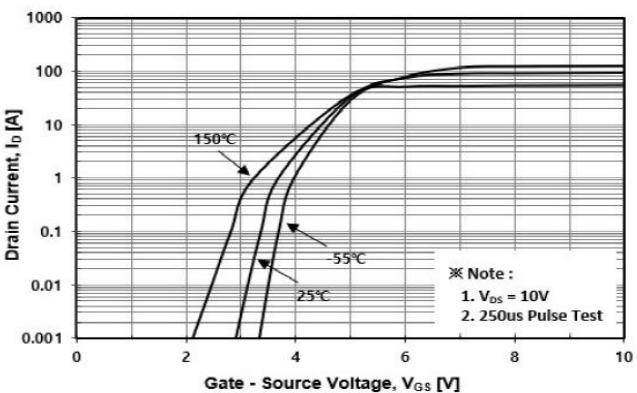


Fig. 3  $R_{DS(ON)}$  -  $I_D$

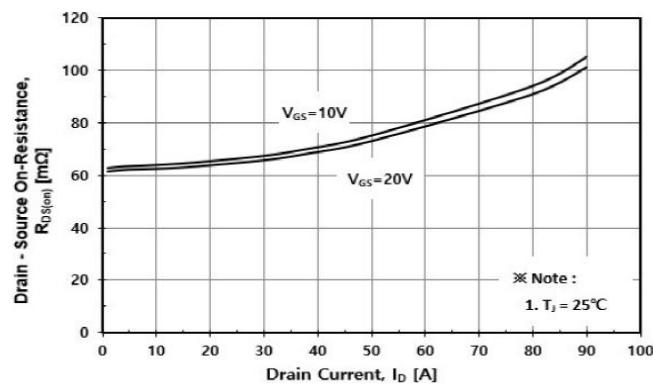


Fig. 4  $I_S$  -  $V_{SD}$

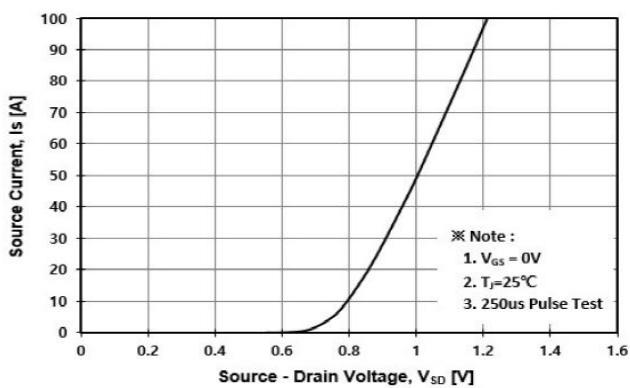


Fig. 5 Capacitance -  $V_{DS}$

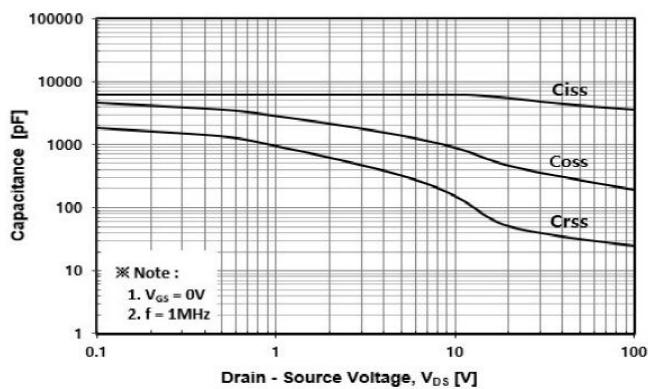
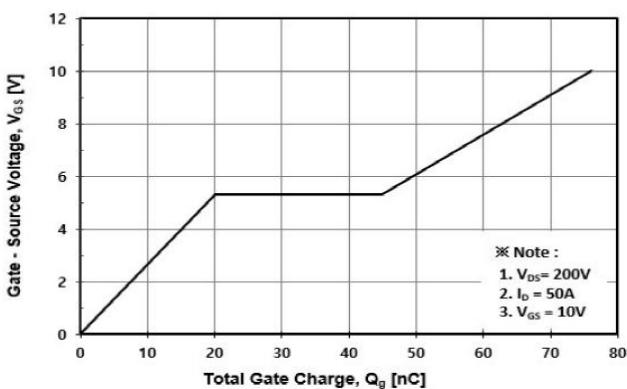


Fig. 6  $V_{GS}$  -  $Q_G$



## Typical Electrical Characteristics Curves

Fig. 7  $BV_{DSS}$  -  $T_J$

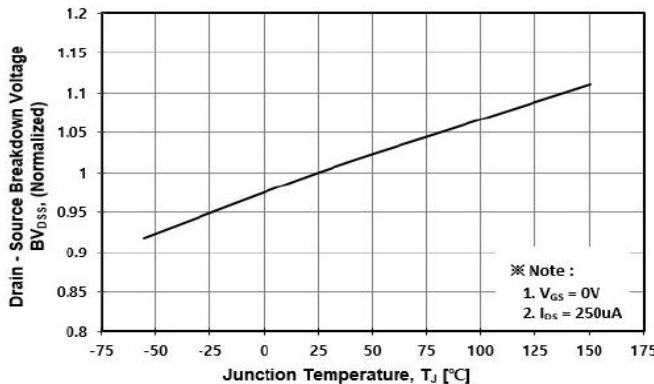


Fig. 8  $R_{DS(ON)}$  -  $T_J$

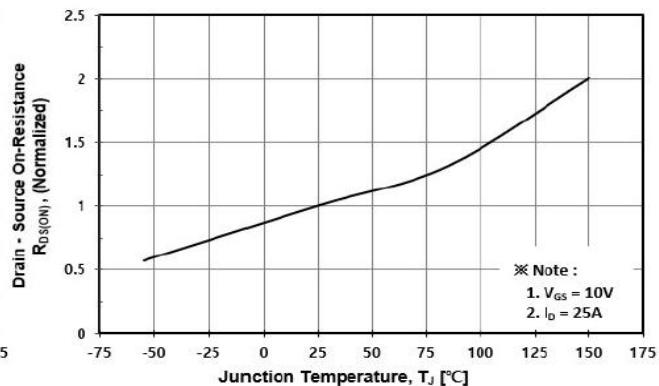


Fig. 9  $I_D$  -  $T_C$

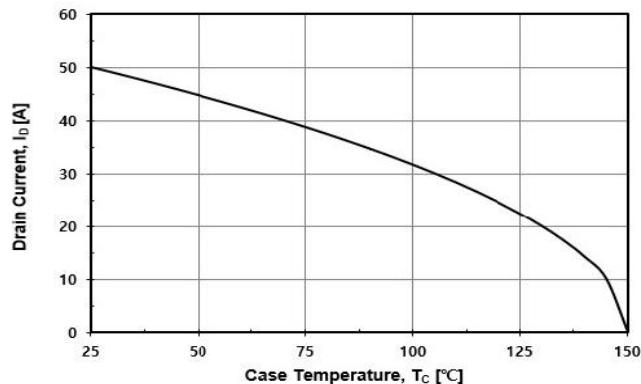


Fig. 10 Safe Operating Area

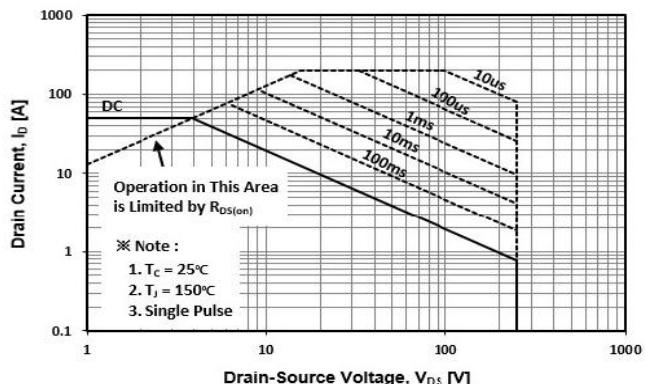
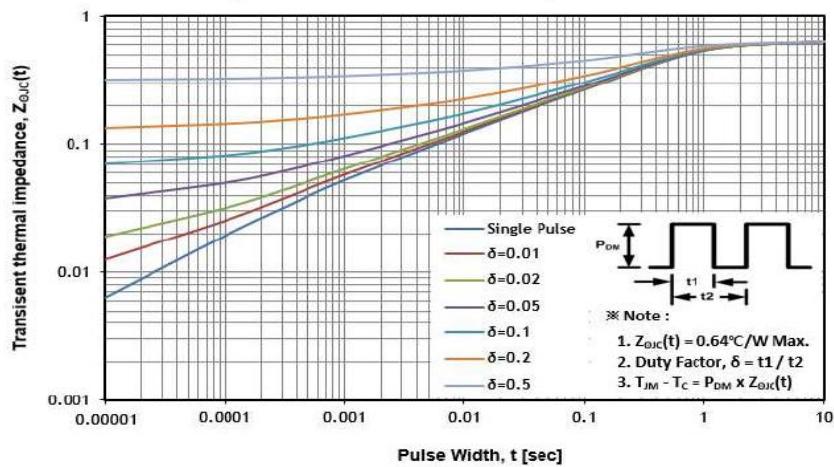


Fig. 11 Transient Thermal Impedance



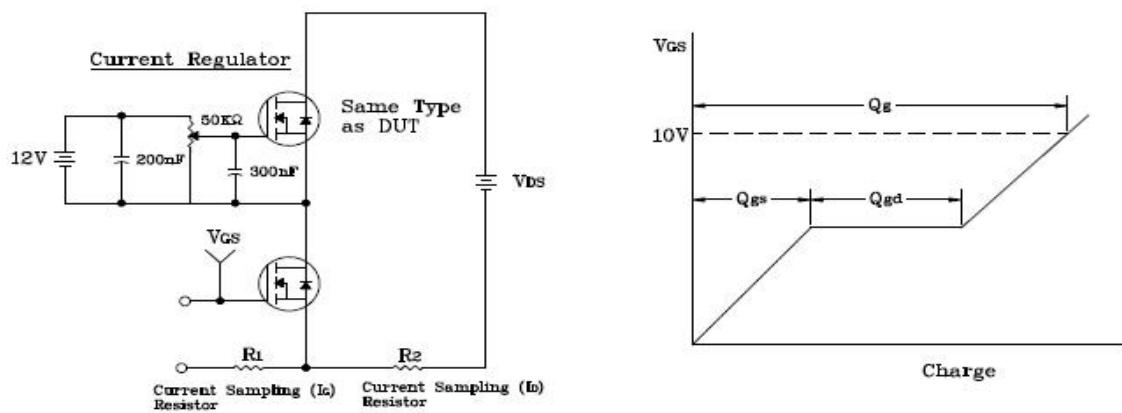
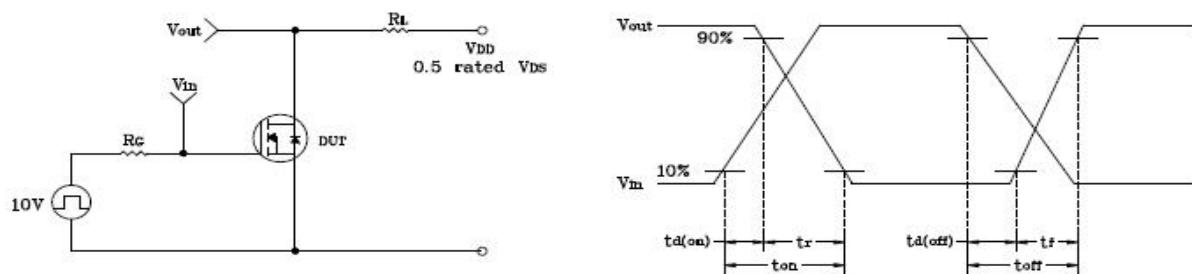
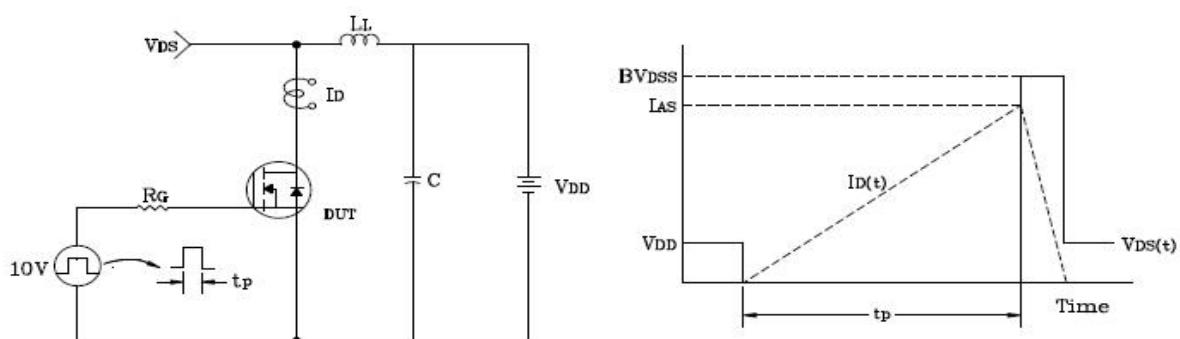
**Fig. 12 Gate Charge Test Circuit & Waveform****Fig. 13 Resistive Switching Test Circuit & Waveform****Fig. 14 E<sub>AS</sub> Test Circuit & Waveform**

Fig. 15 Diode Reverse Recovery Time Test Circuit &amp; Waveform

